ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES® International and Pa	IPC. Bannockł	ourn. Illinois. A	Il rights reserved un ntions.	nder both	This docume level parts, t	ent is a declaratio he declaration en	n of the substand compasses all lo	es within the manufactur wer level materials for w	rer listed i hich the n	tem. Note: if nanufacturer	the item is an as has engineering	ssembly with low responsibility.	
				Form Type ' Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information								
Supplier Information													
Company name* Company			npany unique ID			Unique ID Authority				Response Date*			
onsemi									2025-06-04				
ontact Name Title - Contact					Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Enviro Complia			ro Compliance	ce N		NA			Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			sentative		Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Comple			ro Compliance	Compliance NA			NA			Product-Env-Stewards@onsemi.com			
Requester Item Number	er Item Number Mfr Item Num		Number Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	CS8361	CS8361YDPSR7G ANA 5V DUAL L		.DO REG		2025-06-04	MY1			1421.5	mg	Each	
Anufacturing Proccess Inform	ation					·		·					
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base Alloy		Alloy J	-STD-020 MSL	Rating	Peak Proces	s Body Temper	ature Max Time at Peak	Tempera	ture Numb	er of Reflow Cyc	cles	
Matte Tin (Sn) - annealed CU Alloy 3				260	С	30	secon	nds 3					
omments													
ITENTION: MSL 3 Rated item requir	es Bake and D	ry Pack (after	electrical test)										
or more information regarding materia	l composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chro	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such completes this form. Supplier certifies that it gathered the information it provides in this cortification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in the sparaph. If the Company and the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and/conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter [F] Optionally enter the positive (+) ar				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.19	mg	Supplier	Silicon (Si)	7440-21-3		0.19	mg
Die Attach	11.34	mg	А	Lead (Pb)	7439-92-1	7a	10.773	mg
			Supplier	Tin (Sn)	7440-31-5		0.567	mg
Lead Frame	851.91	mg	В	Nickel (Ni)	7440-02-0		2.5557	mg
			Supplier	Copper (Cu)	7440-50-8		849.3542	mg
Mold Compound-Black	529.31	mg		Epoxy Phenol Resin	proprietary data		55.5775	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		473.7325	mg
Plating	27.15	mg	Supplier	Tin (Sn)	7440-31-5		27.15	mg
Wire Bond - Au	1.6	mg	Supplier	Gold (Au)	7440-57-5		1.6	mg